

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10511992			
<b>Filing Date:</b>	21-Oct-2004			
<b>Title of Invention:</b>	Solvent-free, hot melt adhesive composition comprising a controlled distribution block copolymer			
<b>First Named Inventor/Applicant Name:</b>	Dale L Handlin			
<b>Filer:</b>	Tracy Wesley Druce/Daniel Hernandez			
<b>Attorney Docket Number:</b>	TH1768E/US			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Notice of appeal	1401	1	500	500
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	450	450
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>950</b>